

Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1. (original) A photovoltaic component comprising a bottom electrode, a photovoltaically active layer and, thereon, a top electrode made of a predominantly organic material.
2. (original) The component as described in claim 1, wherein said top electrode is semitransparent.
3. (original) The component as described in claim 1, wherein said top electrode is the positive electrode.
4. (currently amended) The component as described in ~~one of the preceding claims~~ claim 1, wherein leakage connectors are disposed on said top electrode to reduce ohmic losses.
5. (original) The component as described in claim 4, wherein said leakage connectors are made of silver conductive paste.
6. (currently amended) A method for producing a photovoltaic component, wherein applied to a substrate is a bottom conductive functional layer, thereon a semiconductive, photovoltaically active functional layer, and ~~finally~~, a top organic conducting functional layer is applied to said semiconductive, photoactive functional layer.

7. (currently amended) The method as described in claim 6, wherein the top ~~substrate [sic]~~
organic conducting layer is applied by means of printing techniques.
8. (new) The component of claim 1, wherein the top electrode comprises PEDOT.
9. (new) A photovoltaic component, comprising:
 - a first electrode; a photovoltaically active layer; and
 - a second electrode comprising a predominantly organic material; and
 - a photovoltaically active layer between the first and second electrodes.
10. (new) The component of claim 9, wherein the second electrode is semitransparent.
11. (new) The component of claim 10, wherein the second electrode is a positive electrode.
12. (new) The component of claim 9, wherein the second electrode is a positive electrode.
13. (new) The component of claim 9, further comprising leakage connectors disposed on the first electrode.
14. (new) The component of claim 13, wherein the leakage connectors comprise silver conductive paste.